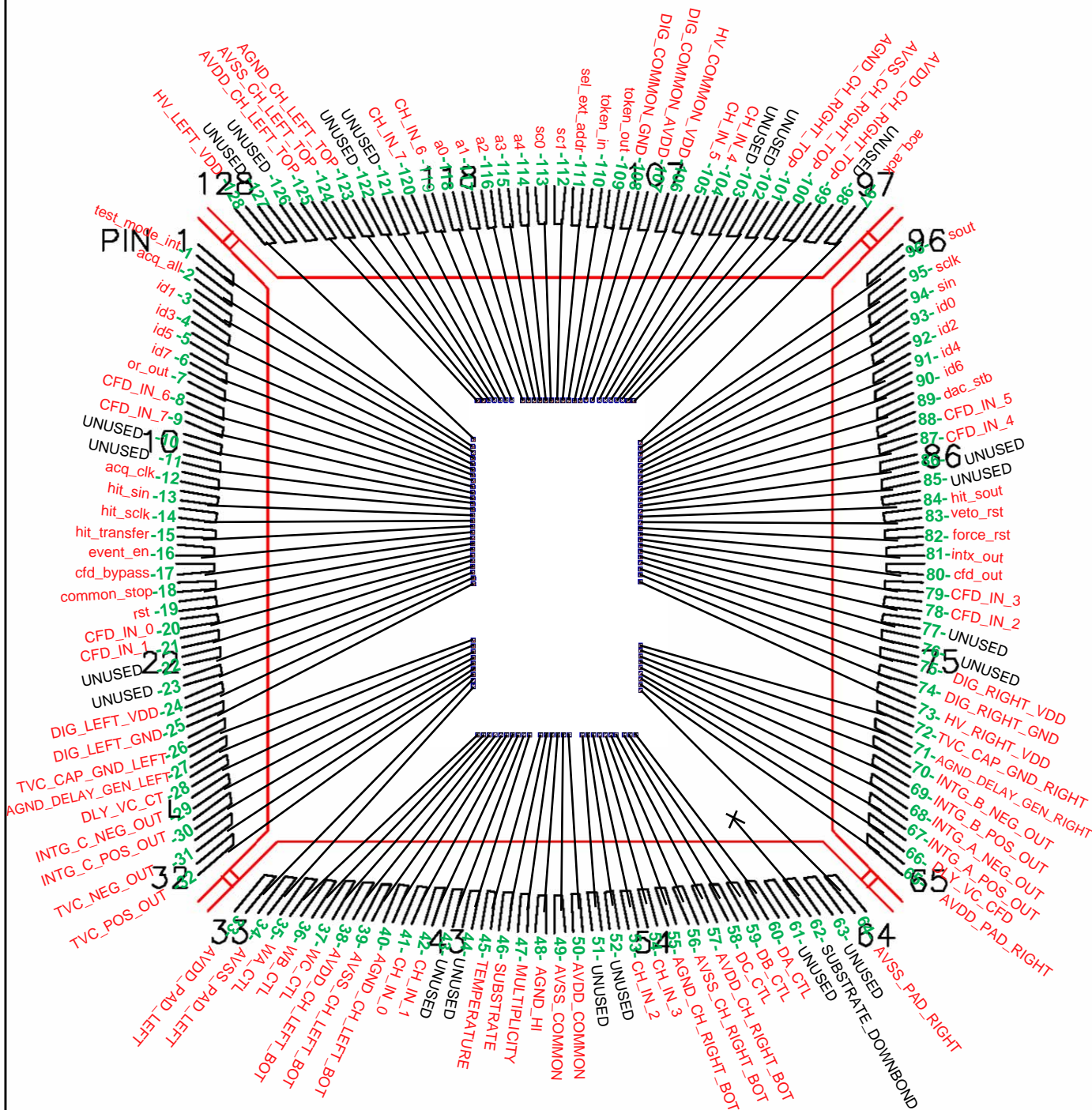


TOP
PSDRev4_11/17/2017

LEFT

RIGHT



BOTTOM

		✓ CHECK PIN 1 DIE ORIENTATION WITH RESPECT TO WAFER FLAT			
REV.	REF.	DESCRIPTION	DATE	DRAWN: Late Reasonable	DATE: 08/09/2000
00-101	A	NEW RELEASE	10/08/00	CHECKED: George Fujimoto	DATE: 08/09/2000
00-100	B	CHANGED INCH TO EX	08/04/00	APPROVED:	DATE:
				DWG. NUMBER: QFP-ED-145Q-128-01	
				ACAD FILENAME: 81281401.DWG	

LEADFRAME:	LF1-H128-201
D/A PAD SIZE:	9.5mm X 9.5mm
SCALE:	DO NOT SCALE DRAWING
TITLE:	BOND SHELL - 14X14X1.4/2.0 QFP, 128 LD
2221 Old Oakland Road San Jose, CA 95131-1402 Phone: (408)321-3600 Fax: (408)321-3603	